

# Update on the analysis of the SiBT summer 2009 beam test data

Jaakko Härkönen  
on behalf of

SiBT Collaboration

<http://www.hip.fi/research/cms/tracker/SiBT/php/home.php>

In framework of

CMS Tracker Upgrade  
RD39 Collaboration  
RD50 Collaboration

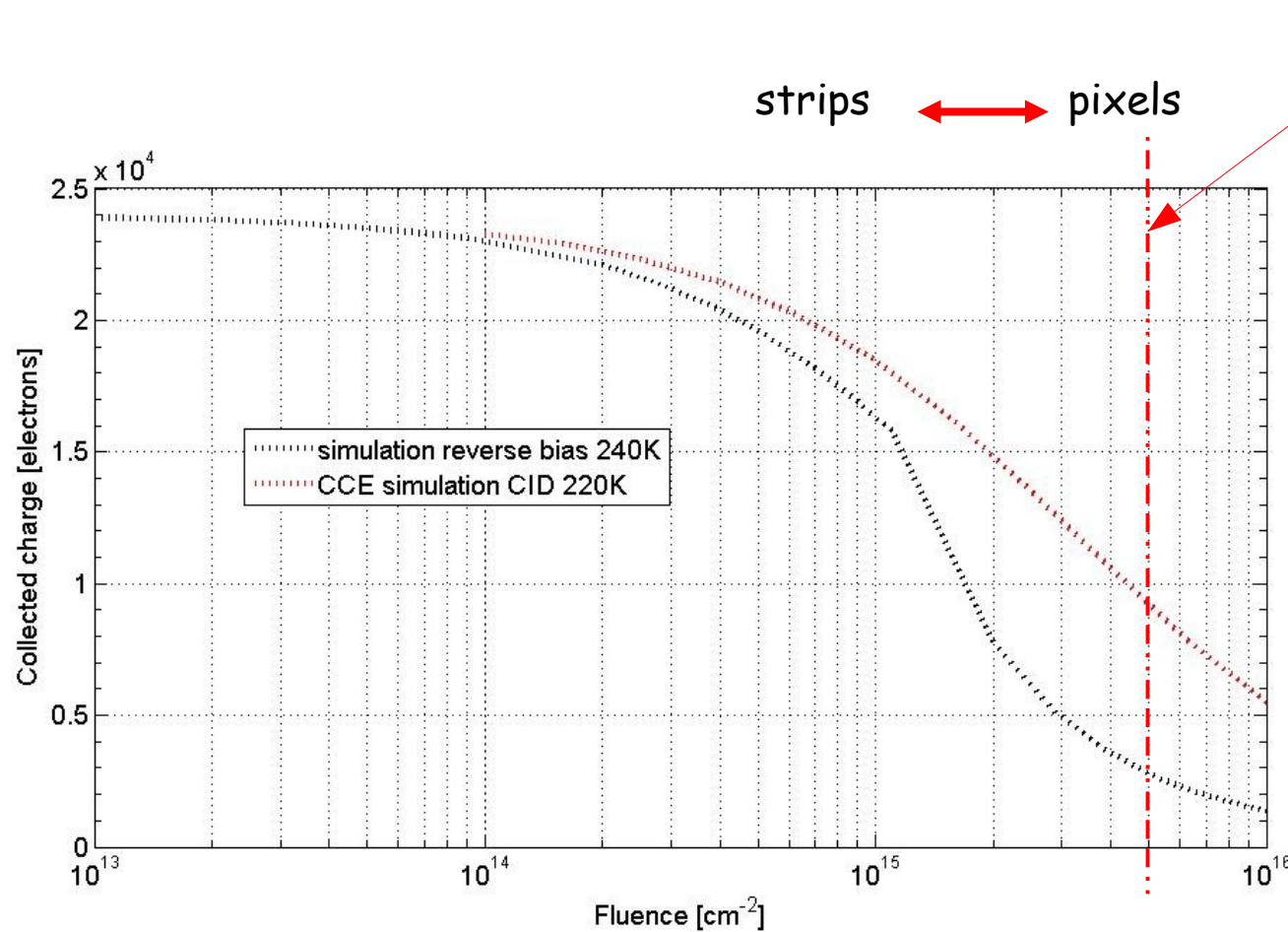
# Motivation and background

- Luminosity increase of LHC by factor of  $\sim 10$  is beyond the radiation hardness of currently existing Si sensors.
- The future Tracker upgrades consume silicon sensors up to 500 m<sup>2</sup>.
- Radiation hardness up to  $1 \times 10^{15} n_{eq}/\text{cm}^2$  is required for strip layers consisting  $>90\%$  of total area.  $1 \times 10^{16} n_{eq}/\text{cm}^2$  for pixels.
- The radiation effects for Si detectors are
  - Increase of full depletion voltage ( $V_{fd}$ )
  - Increase of leakage current ( $I_{leak}$ )
  - Trapping of signal charge (characterized by trapping time constant  $\tau_{e,h}$ )

# Background II -Methods to increase radhard of Si sensors

- Using oxygen rich substrate material = Magnetic Czochralski silicon (MCz-Si) wafers as detector substrate material
  - MCz-Si is less prone for  $V_{fd}$  increase with irradiation
  - MCz-Si provides better electric field distribution  $E(x)$  in irradiated Si leading to better Charge Collection Efficiency (CCE)
- Low temperature (less than  $-30^{\circ}\text{C}$ ) operation
  - Enables Charge Injected Detector (CID) operation.
  - CID is based on balanced trapping and detrapping at low temperature.
  - Radiation defects modify  $E(x)$  if filled by charge injection  $\rightarrow$  detector is “fully depleted all the time.
  - $>2\times$  higher CCE is achieved in CID compared with standard reverse bias operation.

# Evolution of CCE as function of irradiation



Tested up to this fluence during this campaign

- Simulation takes into account linear trapping
- $\beta=0.01 \text{ cm}^{-1}$
- ∇  $\sqrt{x}$  E-field distribution is assumed

$$W_{pin} \propto \left( 1 - \frac{x}{d} \right)$$

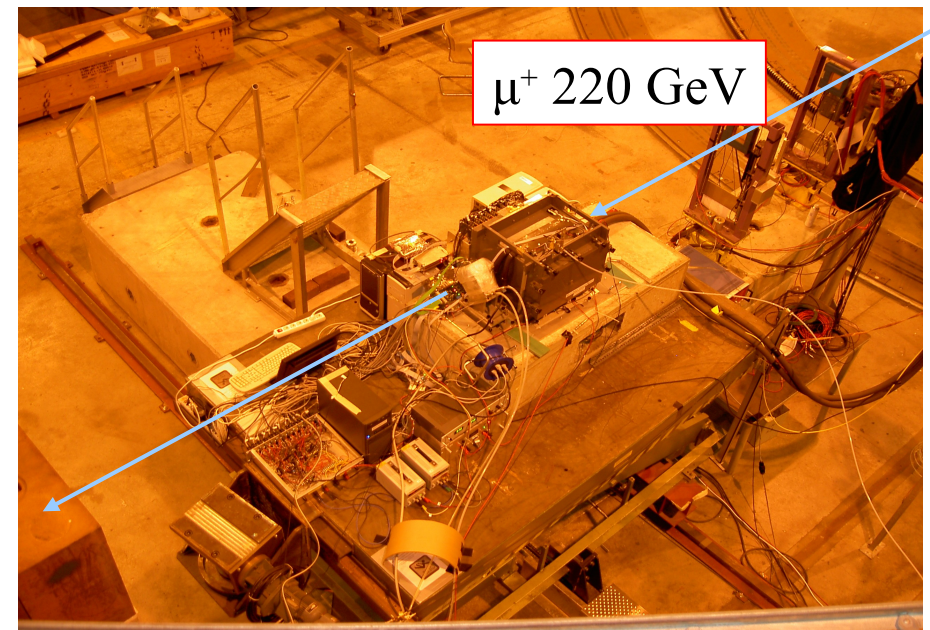
$$W_{CID} \propto \sqrt{x}$$

$$CCE = CCE_{Geometrical} \times CCE_{trapping} = \frac{w}{d} \times e^{-t_{dr}/\tau_{trapping}}$$

$1 \times 10^{14} \text{ n}_{eq}/\text{cm}^2$	$\tau_{trap} = 10 \text{ ns}$
$1 \times 10^{15} \text{ n}_{eq}/\text{cm}^2$	$\tau_{trap} = 1 \text{ ns}$
$1 \times 10^{16} \text{ n}_{eq}/\text{cm}^2$	$\tau_{trap} = 0.1 \text{ ns}$

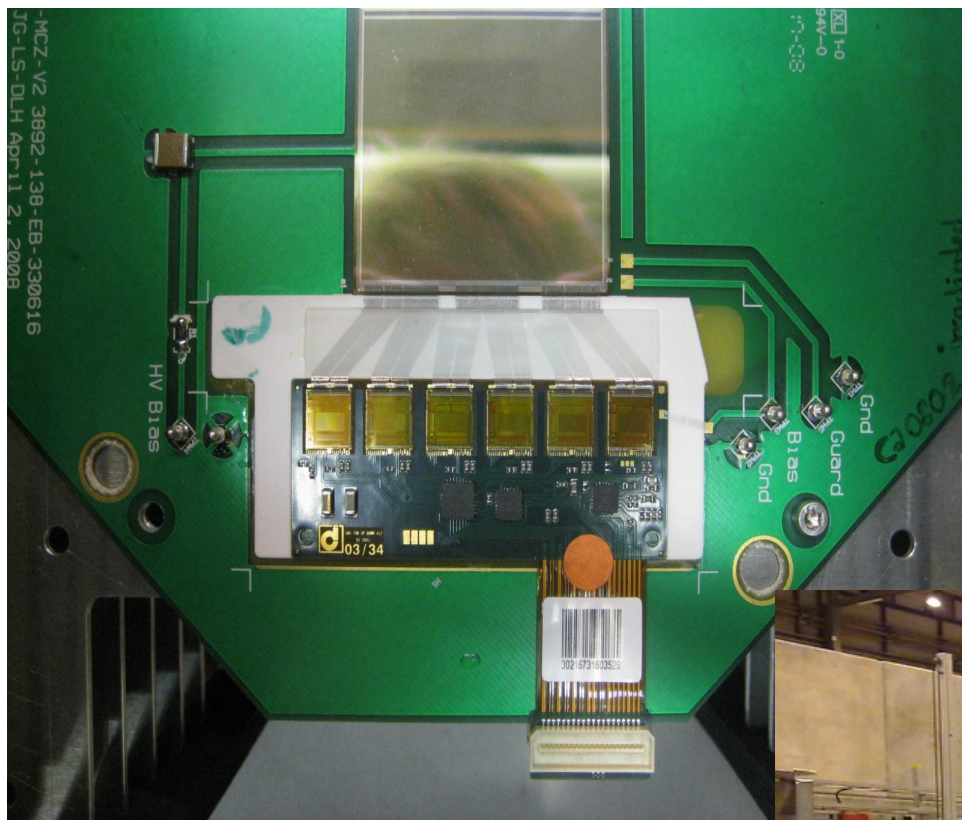
# How Si detector R&D is done at H2 test beam ?

- CMS based read-out electronics (APV25) and DAQ
- 8 detector planes providing reference tracks for DUT
- Measurement down to  $-50^{\circ}\text{C}$
- 50 000 events in about 15min
- Effective area  $4\text{cm} \times 4\text{cm}$
- Telescope resolution  $\sim 4\mu\text{m}$
- Detectors under test processed at Microelectronics Center of Helsinki University of Technology
- Irradiation at Univ. Karlsruhe, 26 MeV protons





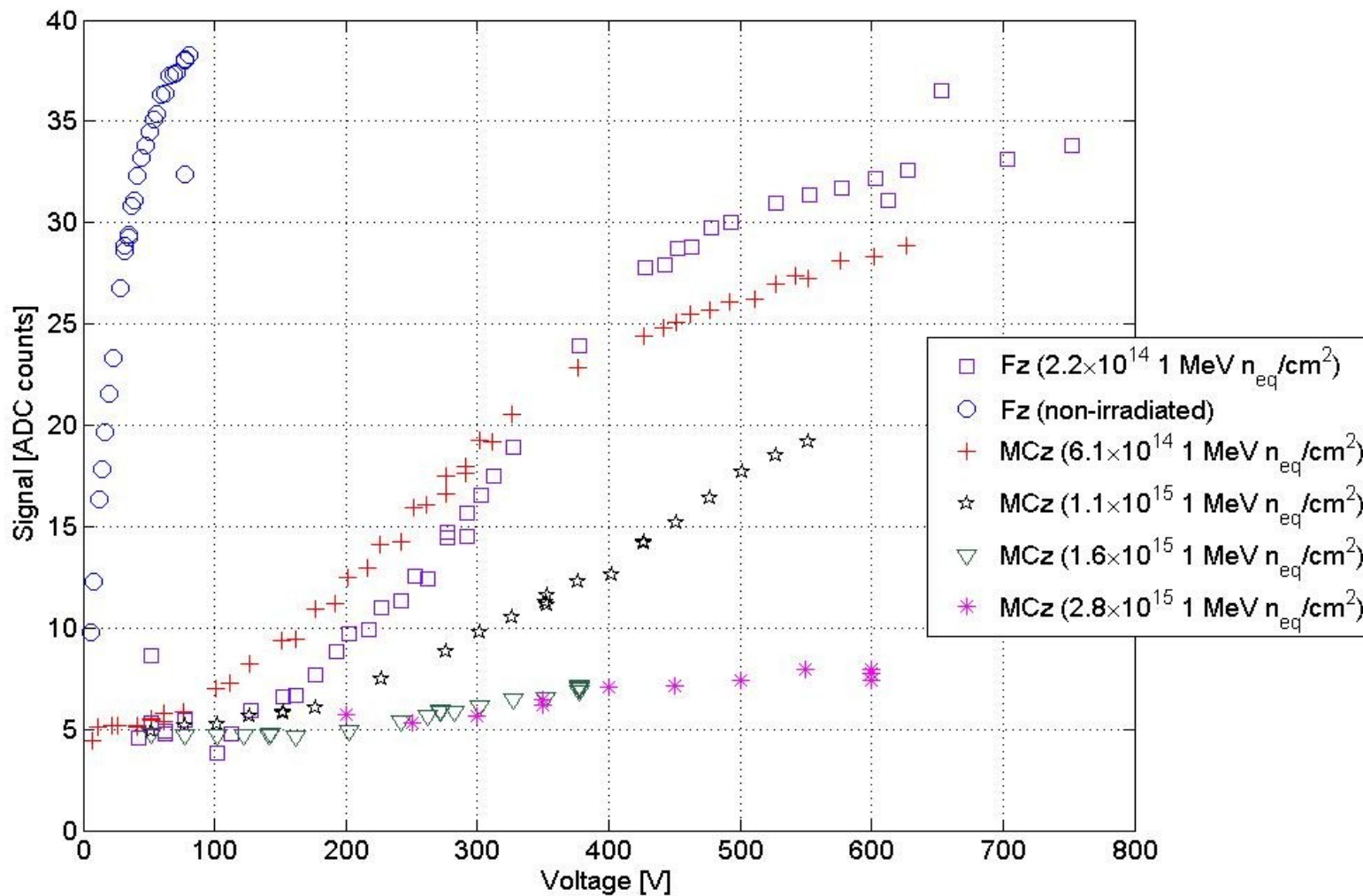
## $5 \times 10^{15} \text{ n}_{\text{eq}}/\text{cm}^2$ irradiated MCz-Si detector with APV read-out



- 768 channels AC-coupled strip detector
- Detector and pitch adapter fabricated by HIP @ Micronova
- 26 MeV proton irradiation @ University Karlsruhe

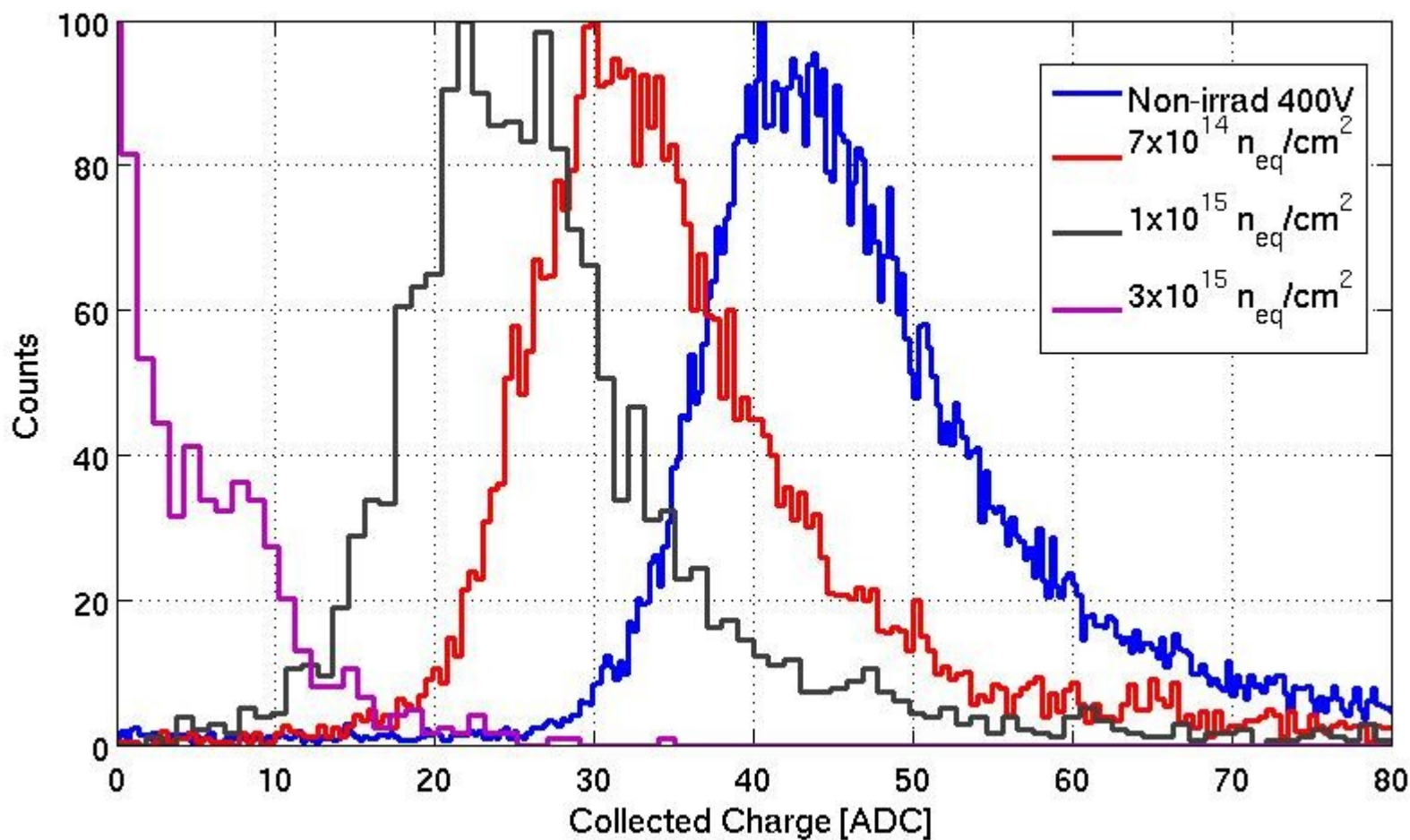


# Results from 2008 (1)



## Results from 2008 (2)

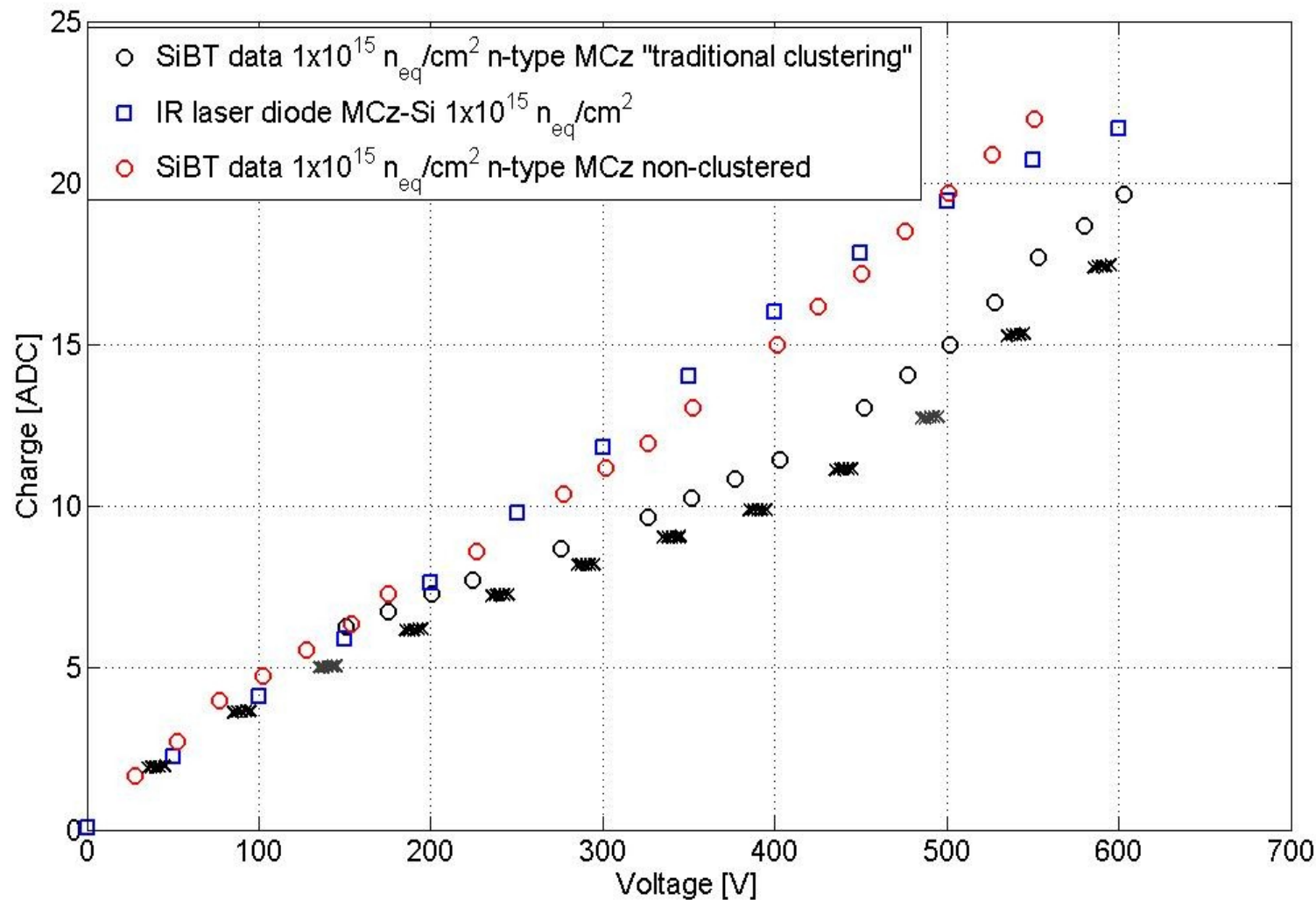
- Signal distributions of n-type MCz-Si detectors
- 100% charge ~40 ADC





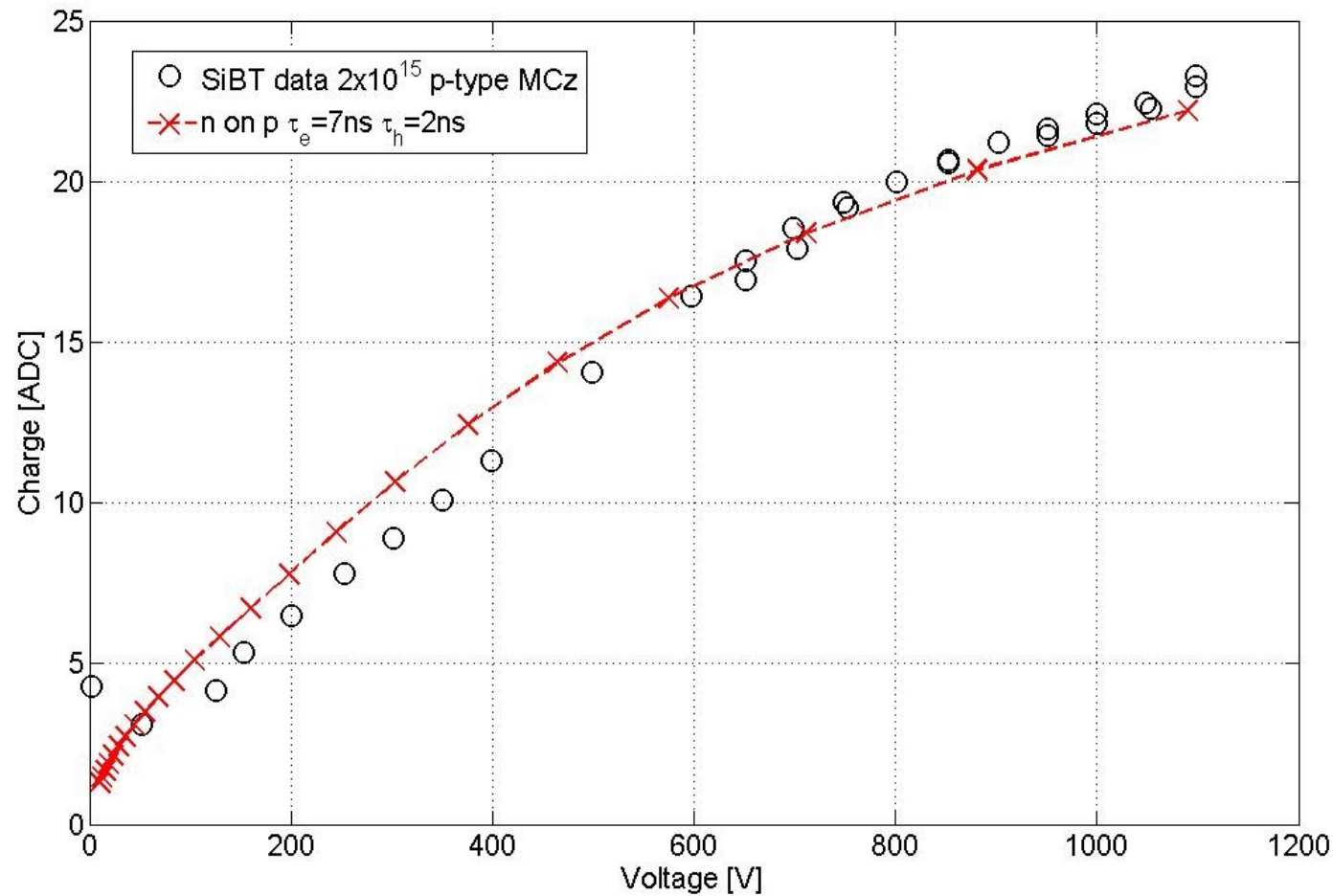
## Results from 2008 (3)

The results are reproduced by IR laser measurements on diodes and calculations of classical electron-hole transport equations.



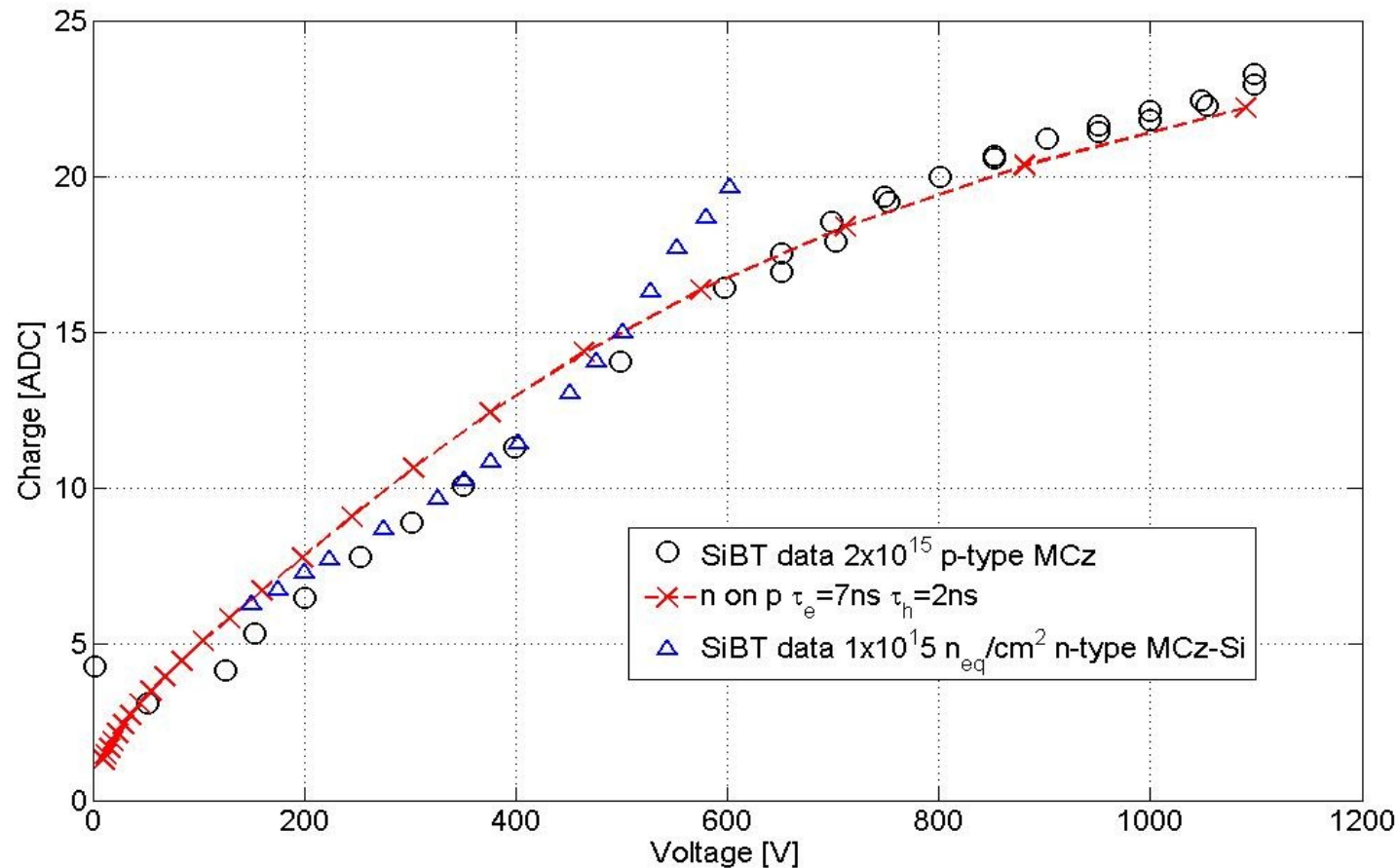
# Results 2009 -Preliminary

$n^+/p^-/p^+$  MCz-Si irradiated  $2 \times 10^{15} n_{eq}/cm^2$

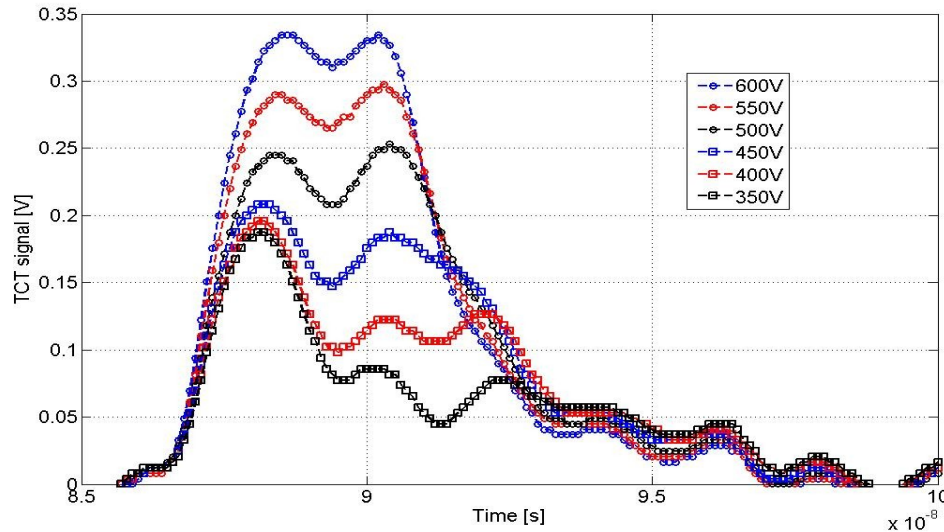


# Comparison on n-type and p-type heavily irradiated MCz-Si detectors

At 600V the n-type MCz-Si shows comparable CCE with p-type MCz-Si irradiated with 2 times higher fluence

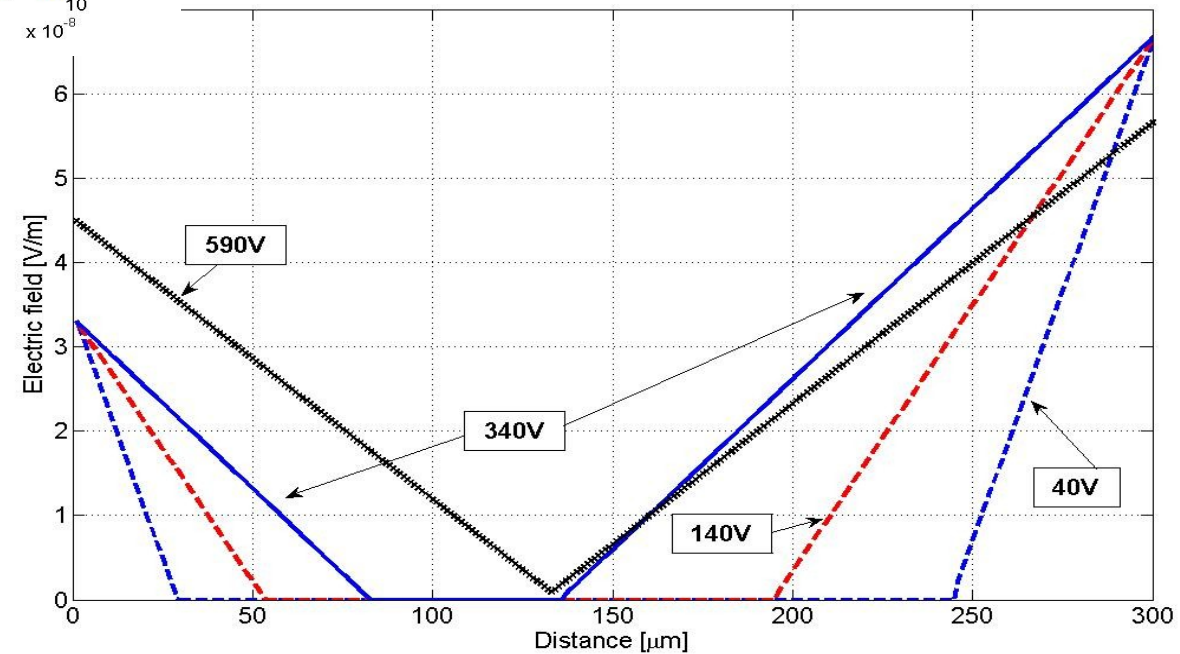


# Electric Field distributions used in simulations - n-type



- RED laser TCT on  $1 \times 10^{15}$  irradiated n-type MCz-Si diode shows clearly Double Junction

E(x) distribution used in simulation





## Summary of test beam period 28.06.-13.07.2009

- > 1Tb High quality data was taken.
- Several different novel detectors were measured, including CID, 3D, thin MCz-Si, p on n structures etc.
- The comprehensive off-line data analysis will take several months. Results will be reported in RD39 and RD50 Workshops and CMS Tracker Upgrade meetings.
- Preliminary results show nice coincidence with classical models for p and n-type MCz-Si both.
- Increase of CMS TK Up Si sensor R&D test beam activity is foreseen in coming years